

IN THE CLAIMS:

1-46. Cancel.

47. (**New**) A method of manufacturing an inorganic LED comprising the steps of:

 providing a growth substrate, and a support member;
 growing on the growth substrate a structure comprising at least one semiconductor layer;
 joining said structure to said support member; and
 removing the growth substrate and subsequently growing at least one further semiconductor layer on said structure.

48. (**New**) A light source comprising at least four inorganic LEDs having different nominal colors of light output from each other.

49. (**New**) A light source according to claim 48 wherein at least two of said LEDs are parts of one chip and are side by side.

50. (**New**) A light source comprising an inorganic LED in which a substantial proportion of the light generated by the LED is wave-guided in the LED; wherein the LED is coated with a phosphor layer that receives substantially all of the wave-guided light of the LED that escapes from the LED.